





SURFACE MOUNT SWITCHING DIODE ARRAY

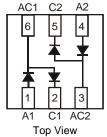
Features

- Fast Switching Speed
- Low Profile DFN Package (0.575mm typical thickness) is Much Thinner than Conventional SOT Style Packages
- Thermally Efficient DFN Package Features 500mW Power Dissipation Capability in a Compact 2.0 * 2.0mm Footprint
- Two "BAV99" Circuits In One Package
- Lead Free/RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Mechanical Data

- Case: DFN2020B-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)





Internal Schematic

Pin 1 = A1 (anode 1, right below the notch indication)

Pin 2 = C1 (cathode 1)

Pin 3 = AC2 (internally connected to rectangular pad)

Pin 4 = A2 (anode 2)

Pin 5 = C2 (cathode 2)

Pin 6 = AC1 (internally connected to the pad with a notch)

Ordering Information (Note 3)

Part Number	Case	Packaging
BAV99BRLP-7	DFN2020B-6	3000/Tape & Reel

Notes:

- 1. No purposefully added lead.
- 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



CK = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

Year	201 ⁻	1	2012		2013	20	14	2015		2016	2	2017
Code	Υ		Z		Α	E	3	С		D		Е
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage		V _{R(RMS)}	53	V
Forward Continuous Current (Note 4)		I _{FM}	300	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0ms @ t = 1.0s	I _{FSM}	3.0 2.0 0.5	А

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 4)	P_D	500	mW
Thermal Resistance Junction to Ambient Air	(Note 4)	$R_{ hetaJA}$	250	°C/W
Operating and Storage Temperature Range		T_J,T_STG	-65 to +150	°C

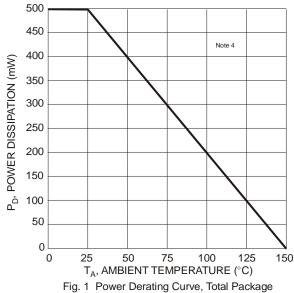
Electrical Characteristics @T_A = 25°C unless otherwise specified

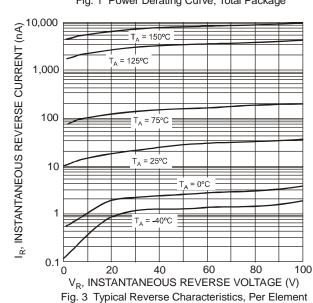
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	75		V	$I_R = 2.5 \mu A$
Forward Voltage	V _F		0.715 0.855 1.0 1.25	٧	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current (Note 5)	I _R	l	2.5 50 30 25		$V_R = 75V$ $V_R = 75V, T_J = 150^{\circ}C$ $V_R = 20V, T_J = 150^{\circ}C$ $V_R = 20V$
Total Capacitance	C _T	1	2.0	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time	t _{rr}		4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

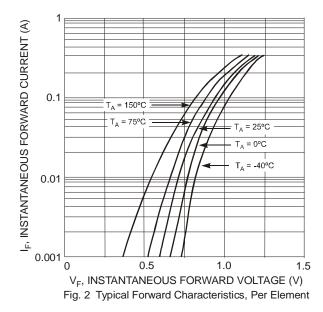
Notes:

- 4. Device mounted on FR-4 PCB, on minimum recommended, 2oz copper pad layout. 5. Short duration pulse test used to minimize self-heating effect.









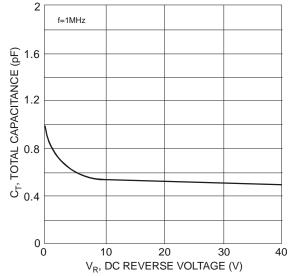
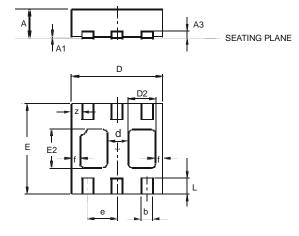


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

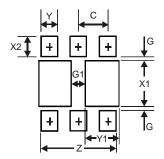


Bottom View

DFN2020B-6						
Dim	Min	Max	Тур			
Α	0.545	0.605	0.575			
A 1	0	0.05	0.02			
A3			0.13			
b	0.20	0.30	0.25			
D	1.95	2.075	2.00			
d		_	0.45			
D2	0.50	0.70	0.60			
е		_	0.65			
Е	1.95	2.075	2.00			
E2	0.90	1.10	1.00			
f	_	_	0.15			
L	0.25	0.35	0.30			
z	_	_	0.225			
All	All Dimensions in mm					



Suggested Pad Layout



Dimensions	Value (in mm)
Z	1.67
G	0.20
G1	0.40
X1	1.0
X2	0.45
Y	0.37
Y1	0.70
С	0.65

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